

65 GHz Broadband Amplifier Module

Features

- 23 dBm saturated output power
- 30 dB gain (to 50 GHz)
- 2.7 W power dissipation
- Useful gain to 65 GHz
- Small size package
- ECCN 3A001.b.4.e

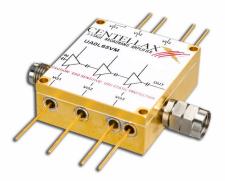
Description

The UA0L65VM Amplifier is a general-purpose broadband amplifier designed for microwave communications, test equipment, and military systems. Its small size and exceptional performance make it a versatile gain block which can improve power and gain in a single hermetically sealed package potentially replacing 2 or 3 narrower band amplifiers.

The UA0L65VM provides a complete amplifier module package with a wide frequency range of 100 kHz to 65 GHz, low power dissipation, ample output power, low noise figure and gain control.

Application

- mm-wave systems
- High frequency test instrumentation
- Broadband gain amplifier



Frequency Domain

Key Characteristics: (Specifications pertain to case temperature range 0 to +75°C,and standard 2.4mm connectors)

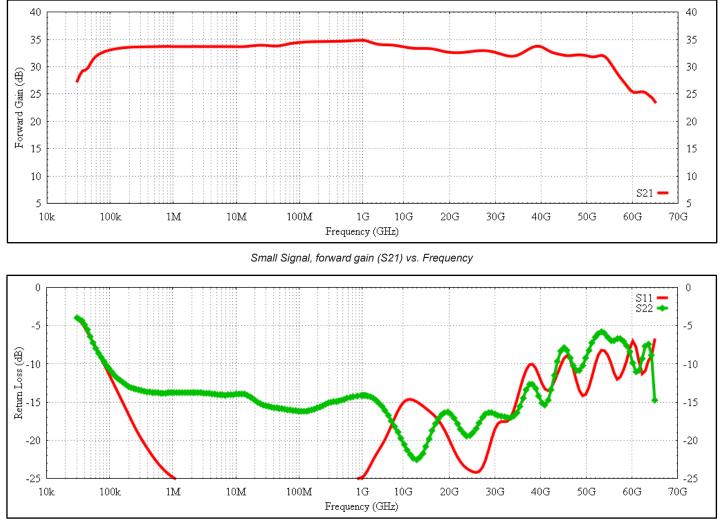
 $Vd1=Vd2=Vd3=7V + -5\%, Vg1=Vg2= -0.15V, Vg3= -0.05V; Zo=50\Omega$

| | | 100kHz - 30GHz | | | 30 - 50GHz | | |
|-----------|-------------------|----------------|-----|-----|------------|-----|-----|
| Parameter | Description | Min | Тур | Мах | Min | Тур | Max |
| S21 (dB) | Small Signal Gain | 27 | 30 | - | 24 | 30 | - |
| S11 (dB) | Input Match | - | -15 | -10 | - | -12 | -4 |
| S22 (dB) | Output Match | - | -15 | -10 | - | -8 | -4 |

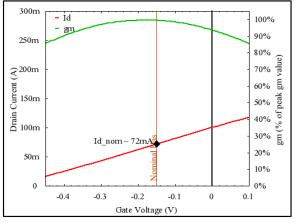
* Vg1/ Vg2/ Vg3 adjusted for peak gm



Typical Performance

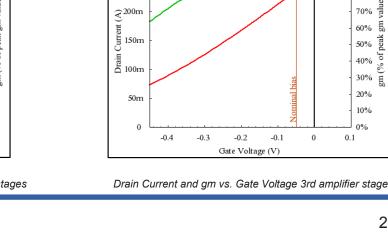


Small signal, input (S11) & output return (S22) loss vs. Frequency



Drain Current and gm vs. Gate Voltage 1st and 2nd amplifier stages

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300m

250m

- Id

– gn

Id_nom ~ 236mA

100%

90%

80%

70%

60%

20%

10%

0%

0.1

0

value)

ES

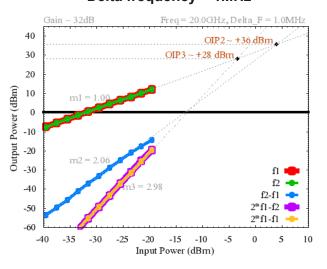
peak 50%

gm (% of 40% 30%



Typical Performance

Two Tone Performance @ 20 GHz Delta frequency = 1MHz



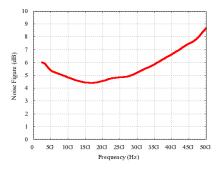
Absolute Maximum Ratings*

| Parameter | Description | Minimum | Maximum |
|--|----------------------|---------|-----------------|
| Vd1 (V) | First Drain Voltage | - | 9 |
| Vd2 (V) | Second Drain Voltage | - | 9 |
| Vd3 (V) | Third Drain Voltage | - | 9 |
| ld1 (mA) | First Drain Current | - | 250 |
| ld3 (mA) | Second Drain Current | - | 250 |
| ld3 (mA) | Third Drain Current | - | 400 |
| Vg1 (V) | First Gate Voltage | -1.5 | 1 |
| Vg2 (V) | Second Gate Voltage | -1.5 | 1 |
| Vg3 (V) | Third Gate Voltage | -1.5 | 1 |
| Storage | e Temperature (C) | -55 | 125 |
| Operating Case Temperature (C) | | -25 | 85 |
| Lead Soldering** (C) | | - | 260° for 3 sec. |
| RF Input Power (dBm) | | - | 20 |
| RF connector torque requirement (in-lb) | | - | 8 |

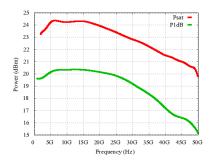
Recommended Operating Bias

| Parameter | Typical |
|---------------------|-----------|
| Vd1=7V, Vg1= -0.15V | ld1=72mA |
| Vd2=7V, Vg2= -0.15V | ld2=72mA |
| Vd3=7V, Vg3= -0.05 | ld3=236mA |
| Power Dissipation | 2.7W |

Noise Figure vs. Frequency



P1db and Psat vs. Frequency

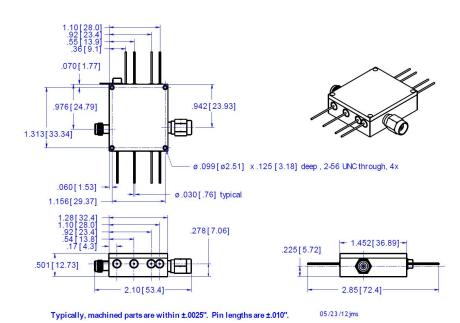


*Operation beyond the values listed under the Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the recommended Operating Bias is not implied. Prolonged use at the absolute maximum rating conditions may affect device reliability. **The use of a heat sink between the component body and the solder joint is highly recommended.

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Physical Dimensions and Pin Assignment



Physical Characteristics

(all measurements in inches[mm])

Tolerance typically +/- 0.0025in (+/- 0.0635mm)

DC pin diameter is 0.03in [0.76mm]

Table 1: UA0L65VM Pin Definition

| Pin | Function | Operational Notes |
|---------|----------------------|---|
| RFin | RF Input | 2.4mm Connector (f) standard, other options available |
| RFout | RF Output | 2.4mm Connector (m) standard, other options available |
| 1 (Vg1) | 1st stage gate bias | Adjust for optimum gain |
| 2 (Vg2) | 2nd stage gate bias | Adjust for optimum gain |
| 3 (Vg3) | 3rd stage gate bias | Adjust for optimum gain |
| 4 | NC | Not Connected |
| 5 (Vd1) | 1st stage drain bias | Set at typical operating specification |
| 6 (Vd2) | 2nd stage drain bias | Set at typical operating specification |
| 7 (Vd3) | 3rd stage drain bias | Set at typical operating specification |
| 8 | NC | Not Connected |

Bias Recommendations (in order):

Downloaded from Arrow.com.

1) Set gate bias to recommended values; 2) Apply Bias Drains; 3) Adjust bias for optimum gain (maximum gm)

Versatile Bias Board (TE1B) Available. Please visit our website for more information



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